DATA SHEET

SILICON POWER TRANSISTOR 2SD2162

NPN SILICON EPITAXIAL TRANSISTOR (DARLINGTON CONNECTION) FOR LOW-FREQUENCY POWER AMPLIFIERS AND LOW-SPEED SWITCHING

The 2SD2162 is a Darlington power transistor that can directly drive from the IC output. This transistor is ideal for motor drivers and solenoid drivers in such as OA and FA equipment.

In addition, a small resin-molded insulation type package contributes to high-density mounting and reduction of mounting cost.

FEATURES

NEC

- High hFE due to Darlington connection hFE \geq 2,000 (VCE = 2.0 V, Ic = 3.0 A)
- Full mold package that does not require an insulating board or insulation bushing

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	Vсво		150	V
Collector to emitter voltage	VCEO		100	V
Emitter to base voltage	Vebo		7.0	V
Collector current (DC)	IC(DC)		+8.0, -5.0	А
Collector current (pulse)	C(pulse)	$PW \le 10 \text{ ms},$	+12, -8.0	Α
		duty cycle $\leq 50\%$		
Base current (DC)	IB(DC)		0.8	А
Total power dissipation	Р⊤	$Tc = 25^{\circ}C$	25	W
		$T_A = 25^{\circ}C$	2.0	W
Junction temperature	Tj		150	°C
Storage temperature	Tstg		-55 to +150	°C

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

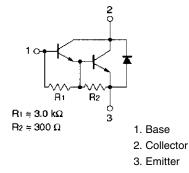
ORDERING INFORMATION

Ordering Name	Package	
2SD2162	Isolated TO-220	

(Isolated TO-220)



INTERNAL EQUIVALENT CIRCUIT



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ELECTRICAL CHARACTERISTICS (TA = 25°C)

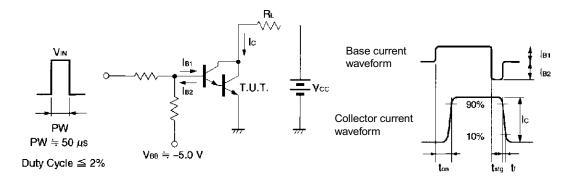
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 100 V, IE = 0 A			1.0	μA
DC current gain	hfe1	$V_{CE} = 2.0 \text{ V}, \text{ Ic} = 3.0 \text{ A}^{Note}$	2,000		15,000	
	hfe2	$V_{CE} = 2.0 \text{ V}, \text{ Ic} = 5.0 \text{ A}^{Note}$	500			
Collector saturation voltage	V _{CE(sat)}	Ic = 3.0 A, I _B = 3.0 mA ^{Note}		0.9	1.5	V
Base saturation voltage	V _{BE(sat)}	$I_{C} = 3.0 \text{ A}, I_{B} = 3.0 \text{ mA}^{Note}$		1.6	2.0	V
Gain bandwidth product	fт	Vce = 5.0 V, Ic = 0.8 A		30		MHz
Collector capacitance	Cob	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0 \text{ A}, \text{ f} = 1.0 \text{ MHz}$		50		pF
Turn-on time	ton	Ic = 3.0 A, RL = 16.7 Ω,		1.0		μs
Storage time	tstg	I _{B1} = −I _{B2} = 3.0 mA, Vcc ≅ 50 V Refer to the test circuit.		3.5		μs
Fall time	tr			1.2		μs

Note Pulse test PW \leq 350 μ s, duty cycle \leq 2%

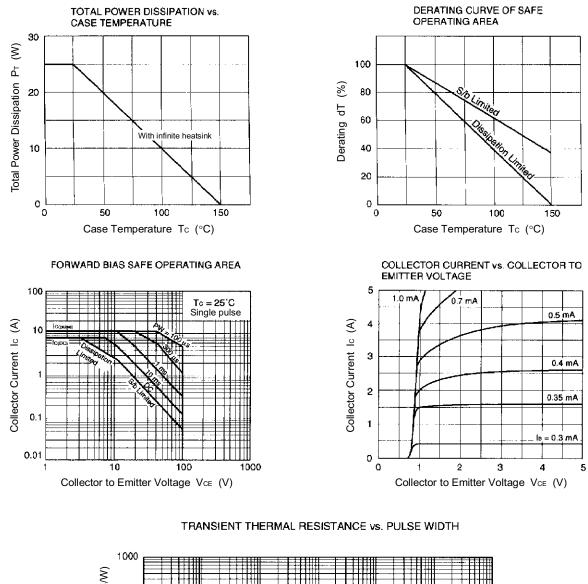
hfe CLASSIFICATION

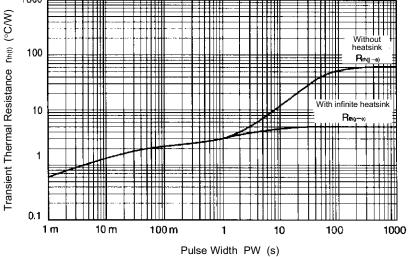
Marking	М	L	к
hfe1	2,000 to 5,000	3,000 to 7,000	5,000 to 15,000

SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT

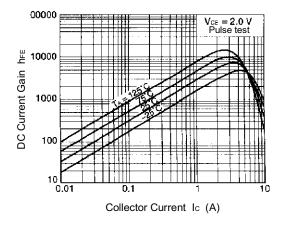


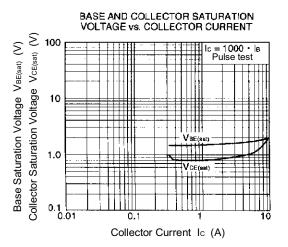






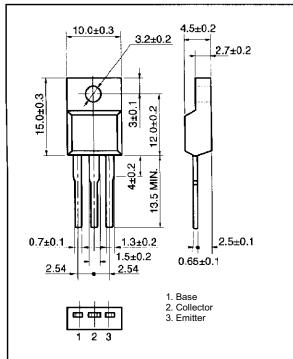
DC CURRENT GAIN vs. COLLECTOR CURRENT





PACKAGE DRAWING (UNIT: mm)





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